Application No.: 10/591,456

## AMENDMENT TO THE CLAIMS

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DEC 0 4 2008

- 1. (Currently amended) An electret condenser, comprising:
- a first electrode;
- a second electrode;
- a first insulating film which is formed between the first electrode and the second electrode and is electretized; and
- a second insulating film formed so as to cover <u>upper</u>, <u>lower and side surfaces of</u> the first insulating film,

wherein the first insulating film covered with the second insulating film is formed on the second electrode.

2. (Currently amended) A method for manufacturing the [[The]] electret condenser of Claim 1,

wherein the first insulting film is a silicon [[oxide]] dioxide film grown in an atmosphere at a temperature in a range between 500 °C and 800 °C, both inclusive.

3. (Currently amended) A method for manufacturing the [[The]] electret condenser of Claim 1,

wherein the second insulting film is a silicon nitride film grown in an atmosphere at a temperature in the range between 600 °C and 800 °C, both inclusive

4. (Original) The electret condenser of Claim 1,

wherein the second electrode, the first insulating film, and the second insulating film compose a vibrating film.

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5. (Original) The electret condenser of Claim 4,

wherein a shape in plan of the first insulating film is smaller than a shape in plan of the vibrating film, and

the first insulating film is arranged at a central part of the vibrating film.

- 6. (Currently amended) An electret condenser, comprising:
- a first electrode;
- a second electrode; and
- a first insulating film which is formed between the first electrode and the second electrode and is electretized,

wherein a lower surface of the first insulating film is covered with the second electrode and upper and side surfaces of the first insulating film are covered with a second insulating film, and

the second electrode is made of polysilicon.

7. (Currently amended) A method for manufacturing the [[The]] electret condenser of Claim 6.

wherein the first insulting film is a silicon [[oxide]] dioxide film grown in an atmosphere at a temperature in a range between 500 °C and 800 °C, both inclusive.

8. (Currently amended) A method for manufacturing the [[The]] electret condenser of Claim 6,

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wherein the second insulting film is a silicon nitride film grown in an atmosphere at a temperature in the range between 600 °C and 800 °C, both inclusive.

9. (Original) The electret condenser of Claim 6,

wherein the second electrode, the first insulating film, and the second insulating film compose a vibrating film.

10. (Original) The electret condenser of Claim 9,

wherein a shape in plan of the first insulating film is smaller than a shape in plan of the vibrating film, and

the first insulating film is arranged at a central part of the vibrating film.